# mail

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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# () IDT.

# 12-OUTPUT DIFFERENTIAL Z-BUFFER FOR PCIE GEN2/3 AND QPI 9ZX21201

## **General Description**

The IDT9ZX21201 is a 12-output DB1200Z suitable for PCI-Express Gen3 or QPI applications. The part is backwards compatible to PCIe Gen1 and Gen2. A fixed external feedback maintains low drift for critical QPI applications. In bypass mode, the IDT9ZX21201 can provide outputs up to 150MHz.

#### **Recommended Application**

12-output PCIe Gen3/ QPI differential buffer for Romley and newer platforms

# **Key Specifications**

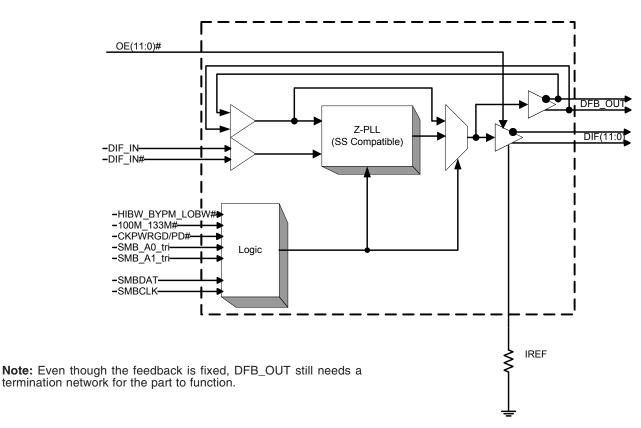
- Cycle-to-cycle jitter <50ps
- Output-to-output skew < 65 ps
- Input-to-output delay variation <50ps</li>
- PCIe Gen3 phase jitter < 1.0ps RMS
- QPI 9.6GT/s 12UI phase jitter < 0.2ps RMS

### Features/Benefits

- Space-saving 64-pin packages
- Fixed feedback path/ 0ps input-to-output delay
- 9 Selectable SMBus Addresses/Mulitple devices can share the same SMBus Segment
- 12 OE# pins/Hardware control of each output
- PLL or bypass mode/PLL can dejitter incoming clock
- 100MHz or 133MHz PLL mode operation/supports PCIe and QPI applications
- Selectable PLL bandwidth/minimizes jitter peaking in downstream PLL's
- Spread Spectrum Compatible/tracks spreading input clock for low EMI
- Software control of PLL Bandwidth and Bypass Settings/ PLL can dejitter incoming clock (B Rev only)

#### **Output Features**

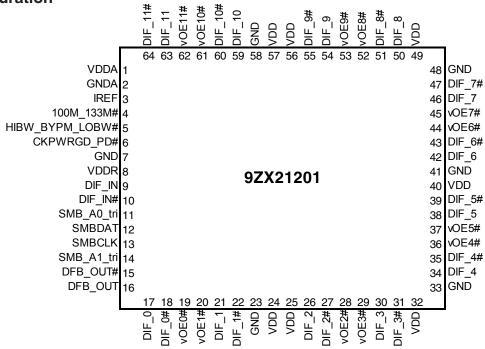
• 12 - 0.7V differential HCSL output pairs



# Functional Block Diagram

9ZX21201 12-Output Differential Z-buffer for PCIe Gen2/3 and QPI

## **Pin Configuration**



Notes: Pins with ^ prefix have internal ~100K pullup Pins with v prefix have internal ~100K pulldown.

#### **Tri-level Input Thresholds**

Level	Voltage
Low	<0.8V
Mid	1.2 <vin<1.8v< td=""></vin<1.8v<>
High	Vin > 2.2V

#### Functionality at Power Up (PLL Mode)

100M_133M#	DIF_IN (MHz)	DIF		
1	100.00	DIF_IN		
0	133.33	DIF_IN		

#### PLL Operating Mode Readback Table

HiBW_BypM_LoBW#	Byte0, bit 7	Byte 0, bit 6
Low (Low BW)	0	0
Mid (Bypass)	0	1
High (High BW)	1	1

#### PLL Operating Mode

HiBW_BypM_LoBW#	MODE
Low	PLL Lo BW
Mid	Bypass
High	PLL Hi BW

NOTE: PLL is OFF in Bypass Mode IDT<sup>®</sup> 12-Output Differential Z-buffer for PCIe Gen2/3 and QPI

#### **MLF Power Connections**

	Pin Number		
VDD	VDD	GND	Description
1		2	Analog PLL
8		7	Analog Input
24,40,57	25,32,49,56	23,33,41,48, 58	DIF clocks

#### 9ZX21201 SMBus Addressing

Pi	n	SMBus Address
SMB_A1_tri	SMB_A0_tri	(Rd/Wrt bit = 0)
0	0	D8
0	М	DA
0	1	DE
М	0	C2
М	М	C4
М	1	C6
1	0	CA
1	М	CC
1	1	CE

# **Pin Description**

PIN #	PIN NAME	TYPE	DESCRIPTION
1	VDDA	PWR	3.3V power for the PLL core.
2	GNDA	PWR	Ground pin for the PLL core.
3	IREF	OUT	This pin establishes the reference for the differential current-mode output pairs. It requires a fixed precision resistor to ground. 4750hm is the standard value for 1000hm differential impedance. Other impedances require different values. See data sheet.
4	100M_133M#	IN	3.3V Input to select operating frequency See Functionality Table for Definition
5	HIBW_BYPM_LOBW#	IN	Trilevel input to select High BW, Bypass or Low BW mode. See PLL Operating Mode Table for Details.
6	CKPWRGD_PD#	IN	Notifies device to sample latched inputs and start up on first high assertion, or exit Power Down Mode on subsequent assertions. Low enters Power Down Mode.
7	GND	PWR	Ground pin.
8	VDDR	PWR	3.3V power for differential input clock (receiver). This VDD should be treated as an analog power rail and filtered appropriately.
9	DIF_IN	IN	0.7 V Differential TRUE input
10	DIF_IN#	IN	0.7 V Differential Complementary Input
11	SMB_A0_tri	IN	SMBus address bit. This is a tri-level input that works in conjunction with the SMB_A1 to decode 1 of 9 SMBus Addresses.
12	SMBDAT	I/O	Data pin of SMBUS circuitry, 5V tolerant
13	SMBCLK	IN	Clock pin of SMBUS circuitry, 5V tolerant
14	SMB_A1_tri	IN	SMBus address bit. This is a tri-level input that works in conjunction with the SMB_A0 to decode 1 of 9 SMBus Addresses.
15	DFB_OUT#	OUT	Complementary half of differential feedback output, provides feedback signal to the PLL for synchronization with input clock to eliminate phase error.
16	DFB_OUT	OUT	True half of differential feedback output, provides feedback signal to the PLL for synchronization with the input clock to eliminate phase error.
17	DIF_0	OUT	0.7V differential true clock output
18	DIF_0#	OUT	0.7V differential Complementary clock output
19	vOE0#	IN	Active low input for enabling DIF pair 0. 1 =disable outputs, 0 = enable outputs
20	vOE1#	IN	Active low input for enabling DIF pair 1. 1 =disable outputs, 0 = enable outputs
21	DIF_1	OUT	0.7V differential true clock output
22	DIF_1#	OUT	0.7V differential Complementary clock output
23	GND	PWR	Ground pin.
24	VDD	PWR	Power supply, nominal 3.3V
25	VDD	PWR	Power supply, nominal 3.3V
26	DIF_2	OUT	0.7V differential true clock output
27	DIF_2#	OUT	0.7V differential Complementary clock output
28	vOE2#	IN	Active low input for enabling DIF pair 2. 1 =disable outputs, 0 = enable outputs
29	vOE3#	IN	Active low input for enabling DIF pair 3. 1 =disable outputs, 0 = enable outputs
30	DIF_3	OUT	0.7V differential true clock output
31	DIF_3#	OUT	0.7V differential Complementary clock output
32	VDD	PWR	Power supply, nominal 3.3V

# **Pin Description (continued)**

33	GND		Ground pin.
34	DIF_4	OUT	0.7V differential true clock output
35	DIF_4#	OUT	0.7V differential Complementary clock output
36	vOE4#	IN	Active low input for enabling DIF pair 4
50	VOL4#	IIN	1 =disable outputs, 0 = enable outputs
37	vOE5#	IN	Active low input for enabling DIF pair 5. This pin has an internal pull-down
- 57		IIN	1 =disable outputs, 0 = enable outputs
38	DIF_5	OUT	0.7V differential true clock output
39	DIF_5#	OUT	0.7V differential Complementary clock output
40	VDD	PWR	Power supply, nominal 3.3V
41	GND	PWR	Ground pin.
42	DIF_6	OUT	0.7V differential true clock output
43	DIF_6#	OUT	0.7V differential Complementary clock output
44	vOE6#	IN	Active low input for enabling DIF pair 6. This pin has an internal pull-down
44	VUE0#	IIN	1 =disable outputs, 0 = enable outputs
45		IN	Active low input for enabling DIF pair 7. This pin has an internal pull-down
45	vOE7#	IIN	1 =disable outputs, 0 = enable outputs
46	DIF_7	OUT	0.7V differential true clock output
47	DIF_7#	OUT	0.7V differential Complementary clock output
48	GND	PWR	Ground pin.
49	VDD	PWR	Power supply, nominal 3.3V
50	DIF_8	OUT	0.7V differential true clock output
51	DIF_8#	OUT	0.7V differential Complementary clock output
50	vOE8#	IN	Active low input for enabling DIF pair 8. This pin has an internal pull-down
52	VUE8#	IIN	1 = disable outputs, $0 =$ enable outputs
50			Active low input for enabling DIF pair 9. This pin has an internal pull-down
53	vOE9#	IN	1 = disable outputs, $0 =$ enable outputs
54	DIF_9	OUT	0.7V differential true clock output
55	DIF_9#	OUT	0.7V differential Complementary clock output
56	VDD	PWR	Power supply, nominal 3.3V
57	VDD	PWR	Power supply, nominal 3.3V
58	GND	PWR	Ground pin.
59	DIF_10	OUT	0.7V differential true clock output
60	DIF_10#	OUT	0.7V differential Complementary clock output
		18.1	Active low input for enabling DIF pair 10. This pin has an internal pull-down
61	vOE10#	IN	1 =disable outputs, 0 = enable outputs
<u> </u>			Active low input for enabling DIF pair 11. This pin has an internal pull-down
62	vOE11#	IN	1 =disable outputs, 0 = enable outputs
63	DIF_11	OUT	0.7V differential true clock output
64	 DIF_11#	OUT	0.7V differential Complementary clock output
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#### **Electrical Characteristics - Absolute Maximum Ratings**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	МАХ	UNITS	NOTES
3.3V Core Supply Voltage	VDD, VDDA	VDD for core logic and PLL			4.6	V	1,2
Input Low Voltage	V <sub>IL</sub>		GND-0.5			V	1
Input High Voltage	V <sub>IH</sub>	Except for SMBus interface			$V_{DD}$ +0.5V	V	1
Input High Voltage	VIHSMB	SMBus clock and data pins			5.5V	V	1
Storage Temperature	Ts		-65		150	°C	1
Junction Temperature	Tj				125	°C	1
Input ESD protection	ESD prot	Human Body Model	2000			V	1

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Operation under these conditions is neither implied nor guaranteed.

#### Electrical Characteristics - Input/Supply/Common Parameters

 $T_A = T_{COM}$ ; Supply Voltage  $V_{DD}/V_{DDA} = 3.3 V + -5\%$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Ambient Operating Temperature	Т <sub>СОМ</sub>	Commmercial range	0		70	°C	1
Input High Voltage	V <sub>IH</sub>	Single-ended inputs, except SMBus, low threshold and tri-level inputs	2		V <sub>DD</sub> + 0.3	V	1
Input Low Voltage	V <sub>IL</sub>	Single-ended inputs, except SMBus, low threshold and tri-level inputs	GND - 0.3		0.8	V	1
	I <sub>IN</sub>	Single-ended inputs, $V_{IN} = GND$ , $V_{IN} = VDD$	-5		5	uA	1
Input Current	I <sub>INP</sub>	Single-ended inputs $V_{IN} = 0 V$ ; Inputs with internal pull-up resistors $V_{IN} = VDD$ ; Inputs with internal pull-down resistors	-200		200	uA	1
	F <sub>ibyp</sub>	V <sub>DD</sub> = 3.3 V, Bypass mode	33		150	MHz	2
Input Frequency	F <sub>ipll</sub>	$V_{DD} = 3.3 \text{ V}, 100 \text{MHz PLL} \text{ mode}$	90	100.00	110	MHz	2
	F <sub>ipll</sub>	V <sub>DD</sub> = 3.3 V, 133.33MHz PLL mode	120	133.33	147	MHz	2
Pin Inductance	L <sub>pin</sub>				7	nH	1
	CIN	Logic Inputs, except DIF_IN	1.5		5	pF	1
Capacitance	C <sub>INDIF_IN</sub>	DIF_IN differential clock inputs	1.5		2.7	pF	1,4
	COUT	Output pin capacitance			6	pF	1
Clk Stabilization	T <sub>STAB</sub>	From V <sub>DD</sub> Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock		0.300	1	ms	1,2
Input SS Modulation Frequency	f <sub>MODIN</sub>	Allowable Frequency (Triangular Modulation)	30		33	kHz	1
OE# Latency	t <sub>LATOE#</sub>	DIF start after OE# assertion DIF stop after OE# deassertion	4	6	12	clocks	1
Tdrive_PD#	t <sub>DRVPD</sub>	DIF output enable after PD# de-assertion		16	300	us	1,3
Tfall	t <sub>F</sub>	Fall time of control inputs			10	ns	1,2
Trise	t <sub>R</sub>	Rise time of control inputs			10	ns	1,2
SMBus Input Low Voltage	VILSMB				0.8	V	1
SMBus Input High Voltage	VIHSMB		2.1		V <sub>DDSMB</sub>	V	1
SMBus Output Low Voltage	V <sub>OLSMB</sub>	@ I <sub>PULLUP</sub>			0.4	V	1
SMBus Sink Current	I <sub>PULLUP</sub>	@ V <sub>OL</sub>	4			mA	1
Nominal Bus Voltage	V <sub>DDSMB</sub>	3V to 5V +/- 10%	2.7		5.5	V	1
SCLK/SDATA Rise Time	t <sub>RSMB</sub>	(Max VIL - 0.15) to (Min VIH + 0.15)			1000	ns	1
SCLK/SDATA Fall Time	t <sub>FSMB</sub>	(Min VIH + 0.15) to (Max VIL - 0.15)			300	ns	1
SMBus Operating Frequency	f <sub>MAXSMB</sub>	Maximum SMBus operating frequency			100	kHz	1,5

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

 $^2\mbox{Control}$  input must be monotonic from 20% to 80% of input swing.

<sup>3</sup>Time from deassertion until outputs are >200 mV

<sup>4</sup>DIF\_IN input

<sup>5</sup>The differential input clock must be running for the SMBus to be active

IDT® 12-Output Differential Z-buffer for PCIe Gen2/3 and QPI

#### **Electrical Characteristics - DIF\_IN Clock Input Parameters**

T<sub>AMB</sub>=T<sub>COM</sub> unless otherwise indicated, Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Input Crossover Voltage - DIF_IN	V <sub>CROSS</sub>	Cross Over Voltage	150		900	mV	1
Input Swing - DIF_IN	V <sub>SWING</sub>	Differential value	300			mV	1
Input Slew Rate - DIF_IN	dv/dt	Measured differentially	0.4		8	V/ns	1,2
Input Leakage Current	I <sub>IN</sub>	$V_{IN} = V_{DD}, V_{IN} = GND$	-5		5	uA	
Input Duty Cycle	d <sub>tin</sub>	Measurement from differential wavefrom	45		55	%	1
Input Jitter - Cycle to Cycle	J <sub>DIFIn</sub>	Differential Measurement	0		125	ps	1

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup>Slew rate measured through +/-75mV window centered around differential zero

#### **Electrical Characteristics - DIF 0.7V Current Mode Differential Outputs**

 $T_A = T_{COM}$ ; Supply Voltage  $V_{DD}/V_{DDA} = 3.3 V + -5\%$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Slew rate	Trf	Scope averaging on	1	2	4	V/ns	1, 2, 3
Slew rate matching	ΔTrf	Slew rate matching, Scope averaging on		8	20	%	1, 2, 4
Voltage High	VHigh	Statistical measurement on single-ended signal using oscilloscope math function. (Scope	660	705	850	mV	1
Voltage Low	VLow		-150	1	150		1
Max Voltage	Vmax	Measurement on single ended signal using		725	1150	mV	1
Min Voltage	Vmin	absolute value. (Scope averaging off)	-300	-22		IIIV	1
Vswing	Vswing	Scope averaging off	300	1407		mV	1, 2
Crossing Voltage (abs)	Vcross_abs	Scope averaging off	250	309	550	mV	1, 5
Crossing Voltage (var)	Δ-Vcross	Scope averaging off		22	140	mV	1, 6

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production. IREF = VDD/( $3xR_{R}$ ). For  $R_{R}$  = 412 $\Omega$  (1%),  $I_{REF}$  = 2.7mA.  $I_{OH}$  = 6.4 x  $I_{REF}$  and  $V_{OH}$  = 0.7V @  $Z_{O}$ =85 $\Omega$  differential impedance.

<sup>2</sup> Measured from differential waveform

<sup>3</sup> Slew rate is measured through the Vswing voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V.

<sup>4</sup> Matching applies to rising edge rate of Clock / falling edge rate of Clock#. It is measured in a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope uses for the edge rate calculations.

<sup>5</sup> Vcross is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

<sup>6</sup> The total variation of all Vcross measurements in any particular system. Note that this is a subset of V\_cross\_min/max (V\_cross absolute) allowed. The intent is to limit Vcross induced modulation by setting V\_cross\_delta to be smaller than V\_cross absolute.

#### **Electrical Characteristics - Current Consumption**

 $T_A = T_{COM}$ ; Supply Voltage  $V_{DD/}V_{DDA} = 3.3 V + -5\%$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Operating Current	IDDVDD	133MHz, $C_L$ = Full load; VDD rail, Zo=85 $\Omega$		260	275	mA	1
Operating Current	I <sub>DDVDDA</sub>	133MHz, $C_L$ = Full load; VDD rail, Zo=85 $\Omega$		13	20	mA	1
Powerdown Current	I <sub>DDVDDPD</sub>	Power Down, VDD rail, Zo=85 $\Omega$		2	6	mA	1
Powerdown Cunent	I <sub>DDVDDAPD</sub>	Power Down, VDD rail, Zo=85 $\Omega$		1.3	2	mA	1

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

#### **Electrical Characteristics - Skew and Differential Jitter Parameters**

 $T_A = T_{COM}$ ; Supply Voltage  $V_{DD}/V_{DDA} = 3.3 V + -5\%$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
CLK_IN, DIF[x:0]	t <sub>SPO_PLL</sub>	Input-to-Output Skew in PLL mode nominal value @ 25°C, 3.3V	-100	29	100	ps	1,2,4,5,8
CLK_IN, DIF[x:0]	t <sub>PD_BYP</sub>	Input-to-Output Skew in Bypass mode nominal value @ 25°C, 3.3V	2.5	3.7	4.5	ns	1,2,3,5,8
CLK_IN, DIF[x:0]	t <sub>DSPO_PLL</sub>	Input-to-Output Skew Varation in PLL mode across voltage and temperature	-50		50	ps	1,2,3,5,8
CLK_IN, DIF[x:0]	t <sub>DSPO_BYP</sub>	Input-to-Output Skew Varation in Bypass mode across voltage and temperature	-250		250	ps	1,2,3,5,8
CLK_IN, DIF[x:0]	t <sub>DTE</sub>	Random Differential Tracking error beween two 9ZX devices in Hi BW Mode		2.9	5	ps (rms)	1,2,3,5,8
CLK_IN, DIF[x:0]	t <sub>DSSTE</sub>	Random Differential Spread Spectrum Tracking error beween two 9ZX devices in Hi BW Mode		14	75	ps	1,2,3,5,8
DIF{x:0]	t <sub>SKEW_ALL</sub>	Output-to-Output Skew across all outputs (Common to Bypass and PLL mode)		32	65	ps	1,2,3,8
PLL Jitter Peaking	jpeak-hibw	LOBW#_BYPASS_HIBW = 1	0	1.8	2.5	dB	7,8
PLL Jitter Peaking	j <sub>peak</sub> -lobw	LOBW#_BYPASS_HIBW = 0	0	0.7	2	dB	7,8
PLL Bandwidth	pll <sub>HIBW</sub>	LOBW#_BYPASS_HIBW = 1	2	3.1	4	MHz	8,9
PLL Bandwidth	pll <sub>LOBW</sub>	LOBW#_BYPASS_HIBW = 0	0.7	1.1	1.4	MHz	8,9
Duty Cycle	t <sub>DC</sub>	Measured differentially, PLL Mode	45	49.6	55	%	1
Duty Cycle Distortion	t <sub>DCD</sub>	Measured differentially, Bypass Mode @100MHz	-2	-0.2	2	%	1,10
Jitter, Cycle to cycle	tinua aux	PLL mode		15.7	50	ps	1,11
	t <sub>jcyc-cyc</sub>	Additive Jitter in Bypass Mode		0.1	50	ps	1,11

#### Notes for preceding table:

<sup>1</sup> Measured into fixed 2 pF load cap. Input to output skew is measured at the first output edge following the corresponding input.

<sup>2</sup> Measured from differential cross-point to differential cross-point. This parameter can be tuned with external feedback path, if present.

<sup>3</sup> All Bypass Mode Input-to-Output specs refer to the timing between an input edge and the specific output edge created by it.

<sup>4</sup> This parameter is deterministic for a given device

<sup>5</sup> Measured with scope averaging on to find mean value.

<sup>6.</sup>t is the period of the input clock

<sup>7</sup> Measured as maximum pass band gain. At frequencies within the loop BW, highest point of magnification is called PLL jitter peaking.

<sup>8.</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>9</sup> Measured at 3 db down or half power point.

<sup>10</sup> Duty cycle distortion is the difference in duty cycle between the output and the input clock when the device is operated in bypass mode.

<sup>11</sup> Measured from differential waveform

#### **Electrical Characteristics - Phase Jitter Parameters**

$T_{A} = T_{COM}$ : Supply Voltage $V_{DD}/V_{DDA} = 3.3 V$	1 +/-5%

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	Notes
	t <sub>jphPCleG1</sub>	PCIe Gen 1		32	86	ps (p-p)	1,2,3
		PCIe Gen 2 Lo Band 10kHz < f < 1.5MHz		0.8	3	ps (rms)	1,2
Phase Jitter, PLL Mode	t <sub>jphPCleG2</sub>	PCIe Gen 2 High Band 1.5MHz < f < Nyquist (50MHz)		1.9	3.1	ps (rms)	1,2
	t <sub>jphPCleG3</sub>	PCIe Gen 3 (PLL BW of 2-4MHz, CDR = 10MHz)		0.45	1	ps (rms)	1,2,4
		QPI & SMI (100MHz or 133MHz, 4.8Gb/s, 6.4Gb/s 12UI)		0.20	0.5	ps (rms)	1,5
	t <sub>jphQPI_SMI</sub>	QPI & SMI (100MHz, 8.0Gb/s, 12UI)		0.14	0.3	ps (rms)	1,5
		QPI & SMI (100MHz, 9.6Gb/s, 12UI)		0.12	0.2	ps (rms)	1,5
	t <sub>jphPCleG1</sub>	PCIe Gen 1		0.10	10	ps (p-p)	1,2,3
		PCIe Gen 2 Lo Band 10kHz < f < 1.5MHz		0.13	0.3	ps (rms)	1,2,6
	t <sub>jphPCleG2</sub>	PCIe Gen 2 High Band 1.5MHz < f < Nyquist (50MHz)		0.10	0.7	ps (rms)	1,2,6
<i>Additive</i> Phase Jitter, Bypass mode	t <sub>jphPCleG3</sub>	PCIe Gen 3 (PLL BW of 2-4MHz, CDR = 10MHz)		0.10	0.3	ps (rms)	1,2,4,6
		QPI & SMI (100MHz or 133MHz, 4.8Gb/s, 6.4Gb/s 12UI)		0.09	0.3	ps (rms)	1,5,6
	t <sub>jphQPI_SMI</sub>	QPI & SMI (100MHz, 8.0Gb/s, 12UI)		0.09	0.1	ps (rms)	1,5,6
		QPI & SMI (100MHz, 9.6Gb/s, 12UI)		0.09	0.1	ps (rms)	1,5,6

<sup>1</sup> Applies to all outputs.

<sup>2</sup> See http://www.pcisig.com for complete specs

<sup>3</sup> Sample size of at least 100K cycles. This figures extrapolates to 108ps pk-pk @ 1M cycles for a BER of 1-12.

<sup>4</sup> Subject to final radification by PCI SIG.

<sup>5</sup> Calculated from Intel-supplied Clock Jitter Tool v 1.6.4

<sup>6</sup> For RMS figures, additive jitter is calculated by solving the following equation: (Additive jitter)<sup>2</sup> = (total jitter)<sup>2</sup> - (input jitter)<sup>2</sup>

#### Power Management Table

Inputs	Co	ntrol Bits/P	Outputs			
CKPWRGD•/PD#	DIF_IN/ DIF_IN#	SMBus EN bit	OE# Pin	DIF(11:0)/ DIF(11:0)#	DFB_OUT/ DFB_OUT#	PLL State
0	Х	Х	Х	Hi-Z <sup>1</sup>	Hi-Z <sup>1</sup>	OFF
		0	Х	Hi-Z <sup>1</sup>	Running	ON
1	Running	1	0	Running	Running	ON
		1	1	Hi-Z <sup>1</sup>	Running	ON

#### NOTE:

1. Due to external pull down resistors, HI-Z results in Low/Low on the True/Complement outputs

				Ν	leasurement	Window				
	Contor	1 Clock	1us	0.1s	0.1s	0.1s	1us	1 Clock		
SSC OFF	Center Freq. MHz	-c2c jitter AbsPer Min	-SSC Short-Term Average Min	- ppm Long-Term Average Min	0 ppm Period Nominal	+ ppm Long-Term Average Max	+SSC Short-Term Average Max	+c2c jitter AbsPer Max	Units	Notes
DIF	100.00	9.94900		9.99900	10.00000	10.00100		10.05100	ns	1,2,3
DIF	133.33	7.44925		7.49925	7.50000	7.50075		7.55075	ns	1,2,4

#### Clock Periods - Differential Outputs with Spread Spectrum Disabled

#### Clock Periods - Differential Outputs with Spread Spectrum Enabled

				Γ	Measurement	Window				
	Contor	1 Clock	1us	0.1s	0.1s	0.1s	1us	1 Clock		
SSC ON	Center Freq. MHz	-c2c jitter AbsPer Min	-SSC Short-Term Average Min	- ppm Long-Term Average Min	0 ppm Period Nominal	+ ppm Long-Term Average Max	+SSC Short-Term Average Max	+c2c jitter AbsPer Max	Units	Notes
DIF	99.75	9.94906	9.99906	10.02406	10.02506	10.02607	10.05107	10.10107	ns	1,2,3
DIF	133.00	7.44930	7.49930	7.51805	7.51880	7.51955	7.53830	7.58830	ns	1,2,4

#### Notes:

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> All Long Term Accuracy specifications are guaranteed with the assumption that the input clock complies with CK420BQ/CK410B+ accuracy requirements (+/-100ppm). The 9ZX21201 itself does not contribute to ppm error.

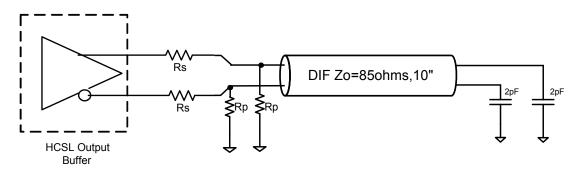
<sup>3</sup> Driven by SRC output of main clock, 100 MHz PLL Mode or Bypass mode

<sup>4</sup> Driven by CPU output of main clock, 133 MHz PLL Mode or Bypass mode

#### Differential Output Termination Table

DIF Zo (Ω)	Iref (Ω)	Rs $(\Omega)$	Rp (Ω)
100	475	33	50
85	412	27	42.2 or 43.2

## 9ZX21201 Differential Test Loads



# General SMBus serial interface information for the 9ZX21201

# How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address XX (H)
- IDT clock will *acknowledge*
- Controller (host) sends the beginning byte location = N
- IDT clock will *acknowledge*
- Controller (host) sends the data byte count = X
- IDT clock will *acknowledge*
- Controller (host) starts sending *Byte N through Byte N + X -1*
- IDT clock will *acknowledge* each byte *one at a time*
- Controller (host) sends a Stop bit

Ind	ex Block W	/rit	e Operation			
Cor	ntroller (Host)		IDT (Slave/Receiver)			
Т	starT bit					
Slave	e Address XX <sub>(H)</sub>					
WR	WRite					
			ACK			
Begi	nning Byte = N					
		ACK				
Data	Byte Count = X					
			ACK			
Begir	ining Byte N					
			ACK			
	$\diamond$	te				
	$\diamond$	X Byte	$\diamond$			
	$\diamond$	×	$\diamond$			
			$\diamond$			
Byte	e N + X - 1					
			ACK			
Р	stoP bit					

Note: XX<sub>(H)</sub> is defined by SMBus address select pins.

# How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the write address XX (H)
- IDT clock will acknowledge
- Controller (host) sends the begining byte location = N
- IDT clock will acknowledge
- Controller (host) will send a separate start bit.
- Controller (host) sends the read addressYY (H)
- IDT clock will acknowledge
- IDT clock will send the data byte count = X
- IDT clock sends Byte N + X -1
- IDT clock sends Byte 0 through byte X (if X<sub>(H)</sub> was written to byte 8).
- Controller (host) will need to acknowledge each byte
- Controllor (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

Ind	ex Block Rea	ad	Operation		
Cor	troller (Host)	ID	T (Slave/Receiver)		
Т	starT bit				
Slave	e Address XX <sub>(H)</sub>				
WR	WRite				
			ACK		
Beginning Byte = N					
			ACK		
RT	Repeat starT				
Slave	e Address YY <sub>(H)</sub>				
RD	ReaD				
			ACK		
		Data Byte Count = X			
	ACK				
			Beginning Byte N		
	ACK				
		Byte	0		
	<b>♦</b>	Ш.	<b>◇</b>		
	$\diamond$	×	$\diamond$		
	<b>O</b>				
	1		Byte N + X - 1		
N	Not acknowledge				
Р	stoP bit				

#### SMBusTable: PLL Mode, and Frequency Select Register

Sin Buorabion i EE mouoj ana i roduonoj eoloot nogisto.								
Byte	e0 Pin #	Name Control Function		Туре	0	1	Default	
Bit 7	5	PLL Mode 1	PLL Mode 1 PLL Operating Mode Rd back 1 R See PLL Operating Mode				Latch	
Bit 6	5	PLL Mode 0	PLL Operating Mode Rd back 0	R	Readba	Latch		
Bit 5		Reserved						
Bit 4		Reserved						
Bit 3	These bits	PLL_SW_EN	Enable S/W control of PLL BW	RW	HW Latch	S/W Control	0	
Bit 2	available in B	PLL Mode 1	PLL Operating Mode 1	RW	See PLL Operating Mode		1	
Bit 1	rev only.	PLL Mode 0	PLL Operating Mode 1	RW	Readback Table		1	
Bit 0	4	100M_133M#	Frequency Select Readback	R	133MHz	100MHz	Latch	

#### SMBusTable: Output Control Register

Byte	1 Pin #	Name	Control Function	Туре	0	1	Default
Bit 7	47/46	DIF_7_En	Output Control - '0' overrides OE# pin	RW			1
Bit 6	43/42	DIF_6_En	Output Control - '0' overrides OE# pin	RW		Enable	1
Bit 5	39/38	DIF_5_En	Output Control - '0' overrides OE# pin	RW			1
Bit 4	35/34	DIF_4_En	Output Control - '0' overrides OE# pin	RW	Low/Low		1
Bit 3	30/31	DIF_3_En	Output Control - '0' overrides OE# pin	RW	LOW/LOW		1
Bit 2	26/27	DIF_2_En	Output Control - '0' overrides OE# pin	RW			1
Bit 1	21/22	DIF_1_En	Output Control - '0' overrides OE# pin	RW			1
Bit 0	17/18	DIF_0_En	Output Control - '0' overrides OE# pin	RW			1

#### SMBusTable: Output Control Register

Byte	Byte 2 Pin #		Name	Control Function	Туре	0	1	Default
Bit 7	it 7 Reserved						0	
Bit 6		Reserved						
Bit 5			Reserved					
Bit 4			Reserved					
Bit 3	64	1/63	DIF_11_En	Output Control - '0' overrides OE# pin	RW			1
Bit 2	59	9/60	DIF_10_En	Output Control - '0' overrides OE# pin	RW	Low/Low Enable		1
Bit 1	54	1/55	DIF_9_En	Output Control - '0' overrides OE# pin	RW			1
Bit 0	50	)/51	DIF_8_En	Output Control - '0' overrides OE# pin	RW		1	

#### SMBusTable: Reserved Register

Byte	Byte 3 Pin #		Name	Control Function	Type	0	1	Default
Bit 7				Reserved				0
Bit 6				Reserved				0
Bit 5		Reserved						
Bit 4			Reserved					
Bit 3				Reserved				0
Bit 2			Reserved					
Bit 1			Reserved					
Bit 0	0 Reserved						0	

#### 9ZX21201 12-Output Differential Z-buffer for PCIe Gen2/3 and QPI

#### SMBusTable: Reserved Register

Byte 4 Pin #		Name	Control Function	Туре	0	1	Default	
Bit 7	Bit 7 Reserved					0		
Bit 6	it 6 Reserved						0	
Bit 5							0	
Bit 4		Reserved						
Bit 3			Reserved				0	
Bit 2							0	
Bit 1		Reserved					0	
Bit 0							0	

#### SMBusTable: Vendor & Revision ID Register

ombaoras	lei teinaei	a novioion is nogiotor							
Byte 5	Pin #	Name	Control Function	Туре	0	1	Default		
Bit 7	-	RID3		R			Х		
Bit 6	-	RID2		R	A rev	A rev = 0000			
Bit 5	-	RID1	REVISION ID R B rev = 0001		= 0001	Х			
Bit 4	-	RID0		R					
Bit 3	-	VID3		R			0		
Bit 2	-	VID2	VENDOR ID	R	0001 fo				
Bit 1	-	VID1	VENDORID	R	000110	0001 for IDT/ICS			
Bit 0	-	VID0		R			1		

#### SMBusTable: DEVICE ID

Byte 6 Pin #		Name	Control Function	Туре	0	1	Default	
Bit 7	-	D	evice ID 7 (MSB)	R		1		
Bit 6	-		Device ID 6	R	]	1		
Bit 5	-		Device ID 5	R	]	0		
Bit 4	-	Device ID 4		R	1001 io 001 do	0		
Bit 3	-		Device ID 3	R	1201 18 201 08	201 decimal or C9 hex		
Bit 2	-	Device ID 2		R	]	0		
Bit 1	-	Device ID 1		R	]		0	
Bit 0	- Device ID 0		R			1		

#### SMBusTable: Byte Count Register

Byte	/te 7 Pin # Name		Name	Control Function	Туре	0	1	Default
Bit 7 Reserved							0	
Bit 6		Reserved						0
Bit 5			Reserved					
Bit 4		-	BC4		RW			0
Bit 3		-	BC3	Writing to this register configures how	RW	Default value	1	
Bit 2		-	BC2	many bytes will be read back.	RW	bytes (0 to 8) w	vill be read back	0
Bit 1		-	BC1	many bytes will be read back.	RW	by de	efault.	0
Bit 0		-	BC0		RW			0

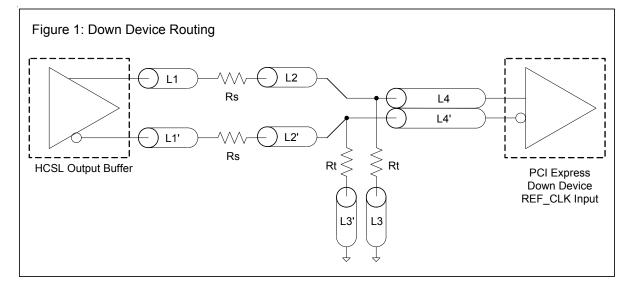
#### SMBusTable: Reserved Register

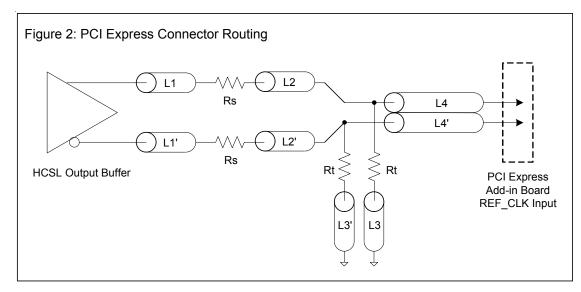
Byte	tyte 8 Pin # Name Contro		Control Function	Туре	0	1	Default	
Bit 7				Reserved				0
Bit 6			Reserved					
Bit 5		Reserved						0
Bit 4			Reserved					
Bit 3				Reserved				0
Bit 2			Reserved					0
Bit 1			Reserved					
Bit 0			Reserved					

DIF Reference Clock							
Common Recommendations for Differential Routing	Dimension or Value	Unit	Figure				
L1 length, route as non-coupled 50ohm trace	0.5 max	inch	1				
L2 length, route as non-coupled 50ohm trace	0.2 max	inch	1				
L3 length, route as non-coupled 50ohm trace	0.2 max	inch	1				
Rs	33	ohm	1				
Rt	49.9	ohm	1				

Down Device Differential Routing			
L4 length, route as coupled microstrip 100ohm differential trace	2 min to 16 max	inch	1
L4 length, route as coupled stripline 100ohm differential trace	1.8 min to 14.4 max	inch	1

Differential Routing to PCI Express Connector			
L4 length, route as coupled microstrip 100ohm differential trace	0.25 to 14 max	inch	2
L4 length, route as coupled stripline 100ohm differential trace	0.225 min to 12.6 max	inch	2



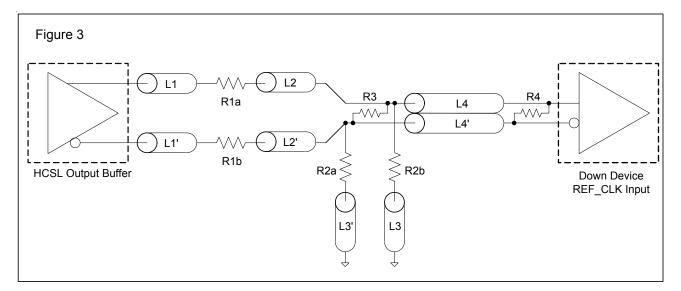


#### 9ZX21201 12-Output Differential Z-buffer for PCIe Gen2/3 and QPI

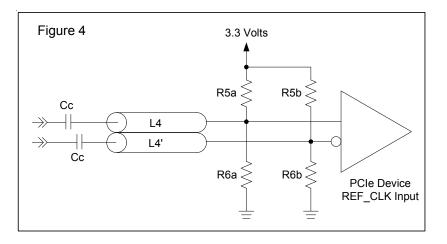
	Alternative Termination for LVDS and other Common Differential Signals (figure 3)								
Vdiff	Vp-р	Vcm	R1	R2	R3	R4	Note		
0.45v	0.22v	1.08	33	150	100	100			
0.58	0.28	0.6	33	78.7	137	100			
0.80	0.40	0.6	33	78.7	none	100	ICS874003i-02 input compatible		
0.60	0.3	1.2	33	174	140	100	Standard LVDS		
P1a = P									

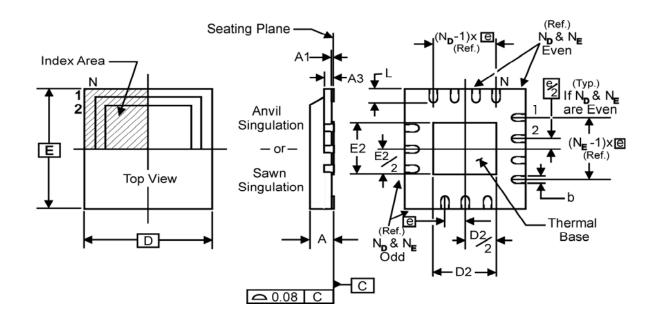
R1a = R1b = R1

R2a = R2b = R2



Cable Connected AC Coupled Application (figure 4)							
Component	Value	Note					
R5a, R5b	8.2K 5%						
R6a, R6b	1K 5%						
Cc	0.1 μF						
Vcm	0.350 volts						





#### THERMALLY ENHANCED, VERY THIN, FINE PITCH QUAD FLAT / NO LEAD PLASTIC PACKAGE

DIMENSIONS

SYMBOL	64L
Ν	64
N <sub>D</sub>	16
N <sub>E</sub>	16

DIMENSIONS (m	im)		
SYMBOL	MIN.	MAX.	
A	0.8	1.0	
A1	0	0.05	
A3	0.25 Reference		
b	0.18	0.3	
е	0.50 BASIC		
D x E BASIC	9.00 x 9.00		
D2 MIN. / MAX.	6.00	6.25	
E2 MIN. / MAX.	6.00	6.25	
L MIN. / MAX.	0.30	0.50	

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# **Ordering Information**

Part / Order Number	Shipping Package	Package	Temperature	Difference	
9ZX21201AKLF	Trays	64-pin MLF	0 to +70°C	W/O Byte 0 PLL Control	
9ZX21201AKLFT	Tape and Reel	64-pin MLF	0 to +70°C		
9ZX21201BKLF	Trays	64-pin MLF	0 to +70°C	With Byte 0 PLL Mode	
9ZX21201BKLFT	Tape and Reel	64-pin MLF	0 to +70°C	Control	

"LF" designates PB-free configuration, RoHS compliant.

"A and B" are the device revision designators (will not correlate with the datasheet revision).

#### **Revision History**

Rev.	Issuer	Issue Date	Description	Page #
A RDW 9/13/2011		1. Updated electrical tables with char data		
	9/13/2011	2. Fixed minor typographical errors	Various	
			3. Moved to final	
B RDW 12/8/2011		1. Added B rev functionality description to Features, Benefits		
	10/0/0011	2. Updated tDSPO_BYP parameter from +/-350ps to +/-250ps	1,7,11,15	
	12/0/2011	3.Updated SMBus Byte 0 with B rev functionality	1,7,11,15	
		4. Updated ordering information to include B rev		
			1. Updated Power connections table to be consistent with 9ZXL1231.	
С	RDW	4/18/20112	2. Updated Rp value for 85 ohm differential Zo from 43.20hms to 42.2 OR	2,9
			43.2 ohms to be consistent with Intel recommendations.	
D	RDW	5/5/2014	1. Fixed error in feedback path on block diagram	1
E RDV		11/19/2015	1. Updated the DIF_IN Input clock specification to align with the PCIe SIG	6
			specification.	0

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#### For Sales

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#### For Tech Support

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#### **Corporate Headquarters**

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road San Jose, CA 95138 United States 800 345 7015 +408 284 8200 (outside U.S.)

#### Asia Pacific and Japan

IDT Singapore Pte. Ltd. 1 Kallang Sector #07-01/06 KolamAyer Industrial Park Singapore 349276 Phone: 65-6-744-3356 Fax: 65-6-744-1764

#### Europe

IDT Europe Limited 321 Kingston Road Leatherhead, Surrey KT22 7TU England Phone: 44-1372-363339 Fax: 44-1372-378851



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